

NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE01P13K uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications. It is ESD protested.

General Features

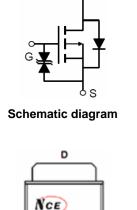
- V_{DS} =-100V,I_D =-13A
 R_{DS(ON)} <200mΩ @ V_{GS}=-10V (Typ:170mΩ)
- Super high dense cell design
- Advanced trench process technology
- Reliable and rugged
- High density celldesign for ultra low on-resistance

Application

- Power switch
- DC/DC converters

100% UIS TESTED!

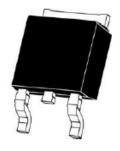
100% ΔVds TESTED!



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Marking and pin assignment



TO-252 -2Ltop view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE01P13K	NCE01P13K	TO-252-2L	-	-	-

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	-100	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	I _D	-13	А
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	-9.2	A
Pulsed Drain Current	I _{DM}	-52	A
Maximum Power Dissipation	PD	40	W
Derating factor		0.27	W /℃
Single pulse avalanche energy (Note 5)	E _{AS}	110	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	്റ
Thermal Characteristic			
Thermal Resistance, Junction-to-Case (Note 2)	R _{θJc}	3.75	°C /W



Electrical Characteristics (T_c=25 $^{\circ}$ Cunless otherwise noted)

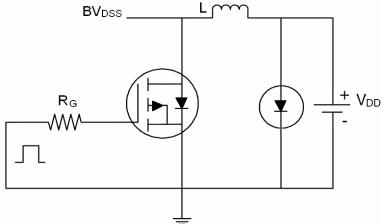
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	•	·	•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-100	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-100V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±10	μA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	V _{DS} =V _{GS} ,I _D =-250µA	-1	-1.9	-3	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-10A	-	170	200	mΩ
Forward Transconductance	g fs	V _{DS} =-5V,I _D =-5A	12	-	-	S
Dynamic Characteristics (Note4)		·	•			
Input Capacitance	C _{lss}		-	1734	-	PF
Output Capacitance	C _{oss}	V _{DS} =-50V,V _{GS} =0V, F=1.0MHz	-	86	-	PF
Reverse Transfer Capacitance	C _{rss}	+=1.0MHz -		40	-	PF
Switching Characteristics (Note 4)		·	•			
Turn-on Delay Time	t _{d(on)}		-	12	-	nS
Turn-on Rise Time	tr	V _{DD} =-50V,I _D =-10A V _{GS} =-10V,R _{GEN} =9.1Ω	-	52	-	nS
Turn-Off Delay Time	t _{d(off)}		-	28	-	nS
Turn-Off Fall Time	t _f		-	38	-	nS
Total Gate Charge	Qg	$y_{1} = 50y_{1} = 400$	-	33.1	-	nC
Gate-Source Charge	Q _{gs}	- V _{DS} =-50V,I _D =-10A,	-	4.2	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =-10V	-	7.1	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-10A	-	-	-1.2	V
Diode Forward Current (Note 2)	ls	-	-	-	-13	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =-10A	-	35	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	46	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

Notes:

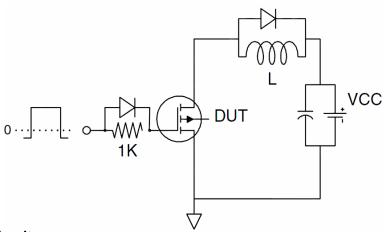
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, t \leq 10 sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition: Tj=25 $^\circ C, V_{DD}$ =-50V, V_G=-10V, L=0.5mH, Rg=25 Ω



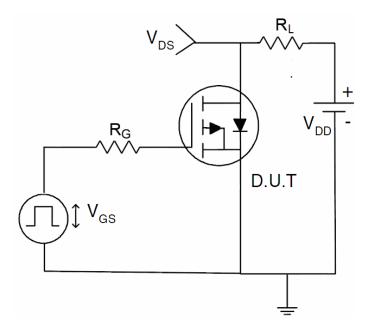
Test Circuit 1) E_{AS} Test Circuit



2) Gate Charge Test Circuit

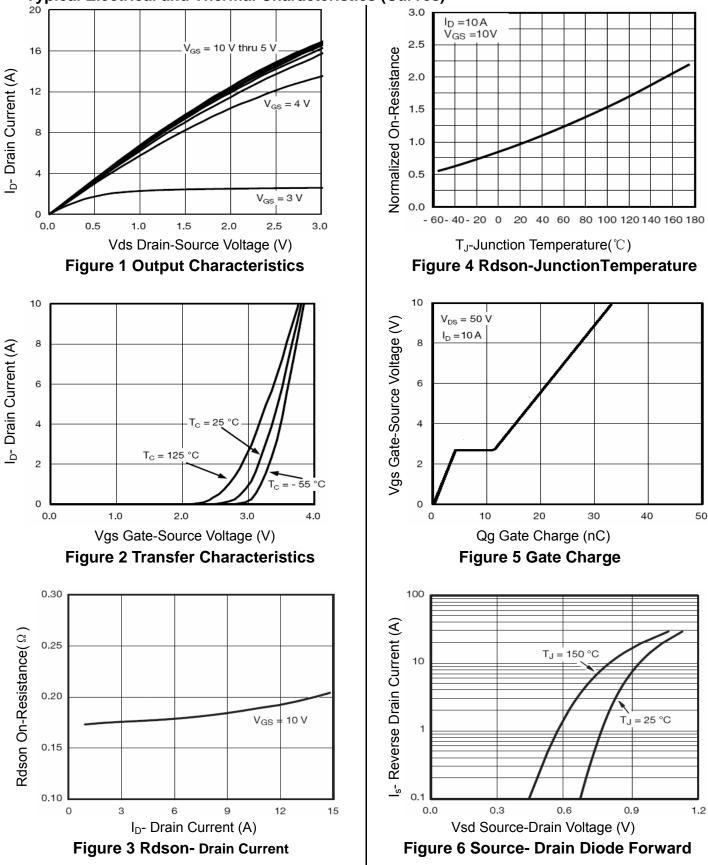


3) Switch Time Test Circuit











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NCE01P13K

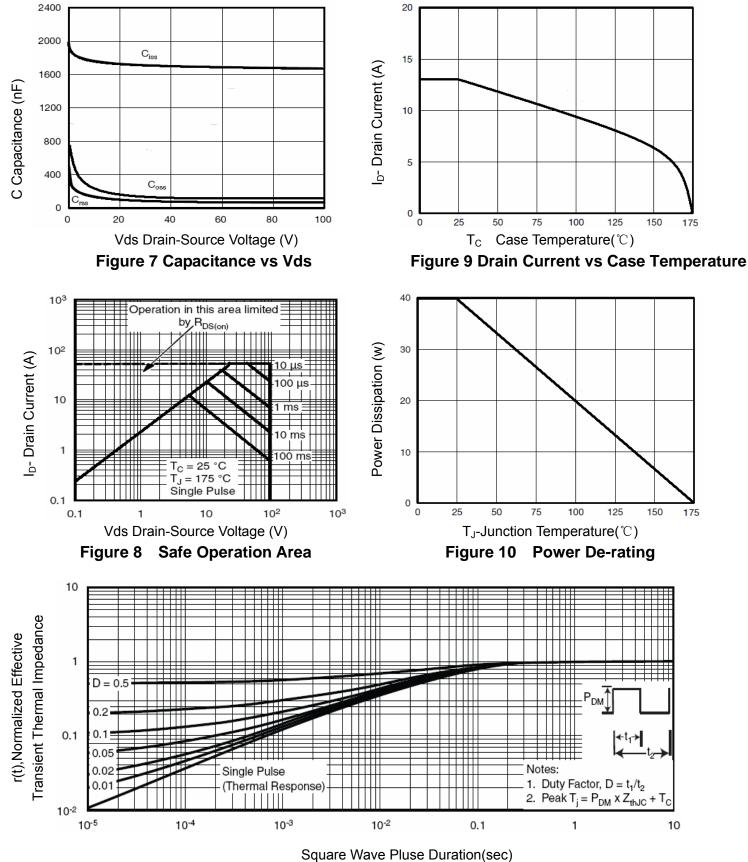
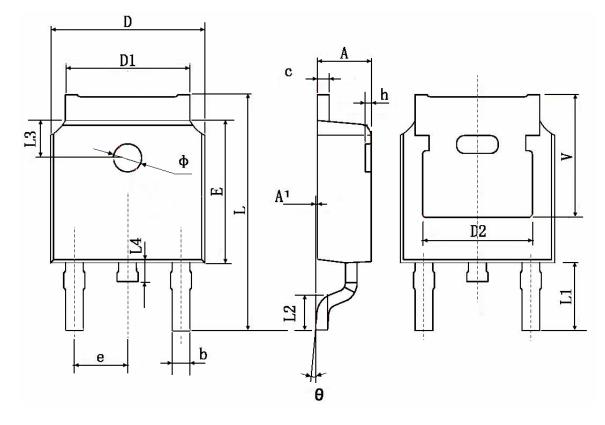


Figure 11 Normalized Maximum Transient Thermal Impedance



TO-252 Package Information



Querra la cal	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.830	D TYP.	0.190 TYP.		
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900 TYP.		0.114 TYP.		
L2	1.400	1.700	0.055	0.067	
L3	1.60	D TYP.	0.063 TYP.		
L4	0.600	1.000	0.024	0.039	
Φ	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.35	D TYP.	0.211 TYP.		



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